

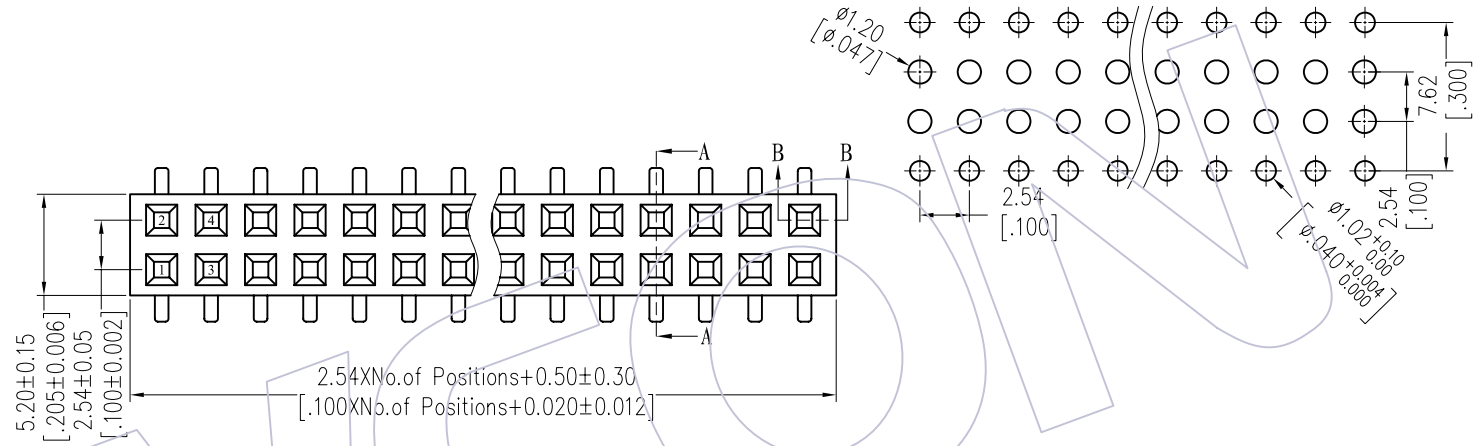
HSF

NOTES:

Current Rating: 3.0AMP
 Contact Resistance: 20mΩ Max
 Withstand Voltage: 1000V AC/DC
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze
 Contact plating: Au Or Sn over Ni
 Insulator Material: PA9T+30%G.F UL94V-0

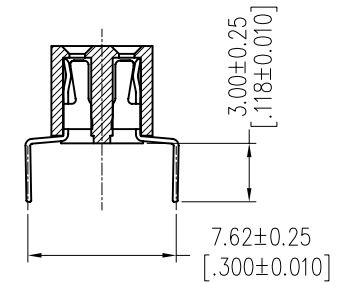
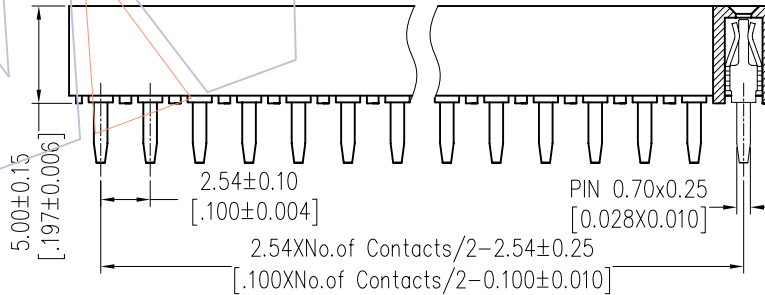
Recommended P.C.B Layout (Top Side)
 (PCB BOARD TOLERANCE ±0.05)



Ordering Information

2150 - 2 XX W XX CUN X 1

- No. of Pins per ROW: 02-40PIN
- Contact Plating:
 G0=Gold Flash
 G3=10μ"Gold
 G4=15μ"Gold
 G5=30μ"Gold
 S0=Gold Flash/Tin
 S3=10μ"Gold/Tin
 S4=15μ"Gold/Tin
 S5=30μ"Gold/Tin
 SN=Tin
 SM=Matte Tin
- Packing:
 T=Tube



Item	Pitch	Mating
Standard	2.54	1115/1120/1125
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
				X.X ±0.40	JYHuang	2012/08/06	UNIT	mm	2150-2XXWXXCUNX1
				X.XX ±0.25	CHECK	DATE	SIZE	A4	
				X.XXX ±0.15	APPROVE	DATE	SHEET	1/1	TITLE: FH2.54 DUAL ROW Centipede (7.62) H=5.0
				Angle ± 3°			PROJ.		Customer NO.
				DIM TOL					